

# MECHANICAL CASE OUTLINE

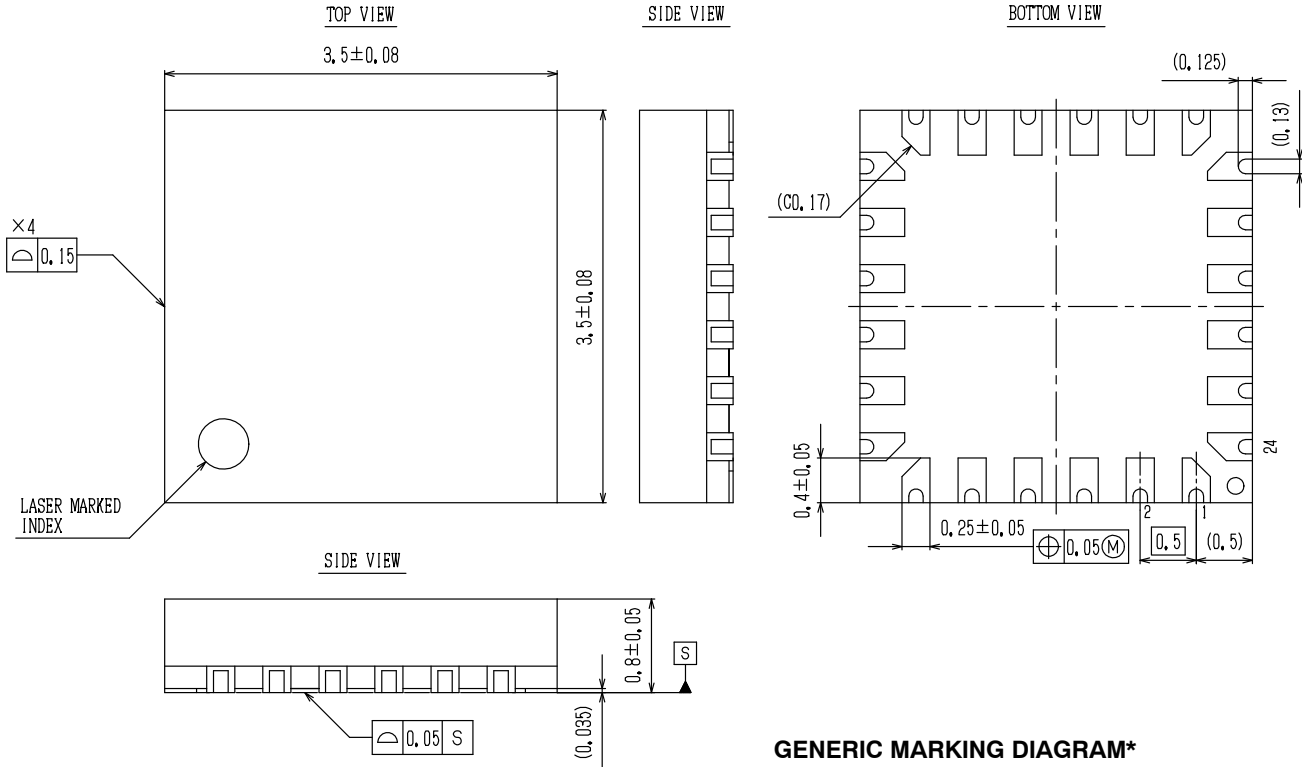
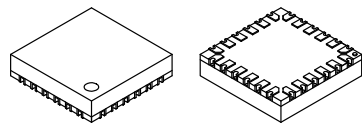
## PACKAGE DIMENSIONS

ON Semiconductor®

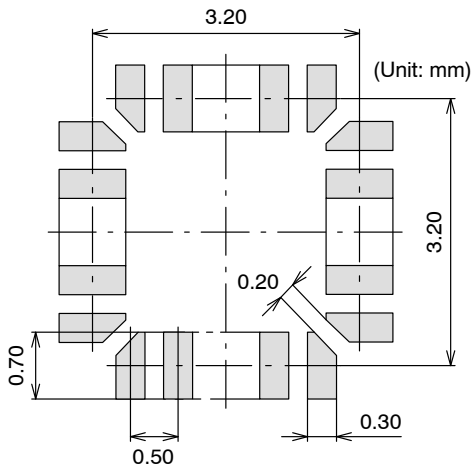


### VCT24 3.5x3.5, 0.5P CASE 601AD ISSUE A

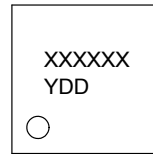
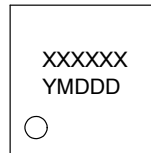
DATE 15 NOV 2013



#### SOLDERING FOOTPRINT\*



#### GENERIC MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
Y = Year  
M = Month  
DDD = Additional Traceability Data

XXXXXX = Specific Device Code  
Y = Year  
DD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>VCT24 3.5X3.5, 0.5P</b>	<b>PAGE 1 OF 1</b>

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